

DESCRIPTION

TITLE OF INVENTION

5

SPUTTERING TARGET

TECHNICAL FIELD

[0001]

The present invention relates to sputtering targets, and in particular, to a sputtering target that contains metallic Co, metallic Pt, and an oxide, and with which a magnetic thin film having a high coercive force can be fabricated.

[0002]

In the present description, the sputtering target that contains metallic Co, metallic Pt, and an oxide may be described as a CoPt-oxide based target. Further, a magnetic thin film that contains metallic Co, metallic Pt, and an oxide may be described as a CoPt alloy-oxide based magnetic thin film.

20 BACKGROUND ART

[0003]

A magnetic disk for a hard disk drive utilizes a magnetic thin film having a granular structure of a CoPt-based alloy-oxide as one example of magnetic recording films that serve to record information signals (see, for example, Non-Patent Literature 1).

The granular structure is composed of columnar CoPt-based alloy crystal grains and crystal grain boundaries formed from an oxide that surrounds the columnar CoPt-based alloy crystal grains. In order to further improve the recording density of the magnetic thin film having the granular structure of the CoPt-based alloy-oxide, there is a need to micronize the CoPt-based alloy crystal grains contained in the magnetic recording layer (magnetic thin film). [0004]

However, the progress of micronization of the CoPt-based alloy crystal grains has resulted in occurrence of the so-called thermal fluctuation phenomenon, in which the superparamagnetic phenomenon impairs the thermal stability of recorded signals and leads to loss of the recorded signals. This thermal fluctuation phenomenon has contributed a major obstacle to increasing the recording density of magnetic disks.

[0005]

In order to surmount this obstacle, the magnetic energy of respective CoPt-based alloy crystal grains needs to be increased such that the magnetic energy exceeds the thermal energy. The magnetic energy of respective CoPt-based alloy crystal grains is obtained by $v \times K_u$, which is a product of the volume v of the CoPt-based alloy crystal grains and the magnetocrystalline anisotropy constant K_u . Therefore, the magnetocrystalline anisotropy constant K_u of the CoPt-based alloy crystal grains needs to be increased in order to increase the magnetic energy (see, for example, Non-Patent

Literature 2).

[0006]

Examples of the measures for increasing K_u of the CoPt-based alloy crystal grains may include one in which stacking faults in
5 respective CoPt-based alloy crystal grains are decreased, and one
in which the periodicity of the stacking structure of Co atoms and
Pt atoms is improved (see, for example, Non-Patent Literatures 3
and 4).

[0007]

10 On the other hand, in order to grow the CoPt-based alloy crystal
grains having large K_u in a columnar shape, phase separation between
the CoPt-based alloy crystal grains and grain boundary material
must be achieved. If the phase separation between the CoPt-based
alloy crystal grains and the grain boundary material is insufficient
15 to increase the grain interaction between the CoPt-based alloy
crystal grains, the magnetic thin film having the granular structure
of the CoPt-based alloy-oxide has had reduced coercive force H_c .
As a result, the thermal stability is impaired, and the thermal
fluctuation phenomenon may occur with ease. Thus, it is important
20 to reduce the grain interaction between the CoPt-based alloy crystal
grains.

[0008]

In order to satisfy the foregoing requirements, various oxides
have been investigated for use as grain boundary materials for the
25 CoPt-based alloy crystal grains (see, for example, Non-Patent

Literatures 5 and 6). However, there is no clear guideline for selecting materials, and even today, the investigation for searching oxides used as grain boundary materials for the CoPt-based alloy crystal grains is being continued.

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CITATION LIST

Non-Patent Literature

[0009]

Non-Patent Literature 1: T. Oikawa et al., IEEE TRANSACTIONS
10 ON MAGNETICS, Sep. 2002, VOL.38, NO.5, p.1976-1978

Non-Patent Literature 2: S. N. Piramanayagam, JOURNAL OF
APPLIED PHYSICS, 2007, 102, 011301

Non-Patent Literature 3: A. Ishikawa and R. Sinclair, IEEE
TRANSACTIONS ON MAGNETICS, Sep. 1996, VOL.32, NO.5, p.3605-3607

15 Non-Patent Literature 4: S. Saito, S. Hinata, and M. Takahashi,
IEEE TRANSACTIONS ON MAGNETICS, Mar. 2014, VOL.50, NO.3, 3201205

Non-Patent Literature 5: J. Ariake, T. Chiba, and N. Honda,
IEEE TRANSACTIONS ON MAGNETICS, Oct. 2005, VOL.41, NO.10,
p.3142-3144

20 Non-Patent Literature 6: V. Sokalski, J. Zhu., and D. E.
Laughlin, IEEE TRANSACTIONS ON MAGNETICS, Jun. 2010, VOL.46, NO.6,
p.2260-2263

SUMMARY OF INVENTION

25 Technical Problem

[0010]

In light of such circumstances, an object of the present invention is to provide a sputtering target with which it is possible to form a magnetic thin film having a high coercive force H_c .

5

Solution to Problem

[0011]

The inventors of the present invention have diligently carried out studies to solve the above-mentioned problems. As a result, the inventors have found that the oxide suitable for increasing the coercive force H_c of the magnetic thin film is an oxide having a melting point of 600°C or lower and a standard Gibbs free energy of formation ΔG_f with respect to 1mol O_2 being $-1,000\text{ kJ/mol O}_2$ or more and -500 kJ/mol O_2 or less.

15 [0012]

The present invention has been made on the basis of this new findings.

[0013]

Namely, an aspect of a sputtering target according to the present invention is a sputtering target comprising metallic Co, metallic Pt, and an oxide, wherein the sputtering target contains no metallic Cr except inevitable impurities, the oxide consists of only B_2O_3 , and the sputtering target comprises 10 to 50 vol% of the B_2O_3 .

25 [0014]

[0015]

[0016]

It is preferable that the sputtering target comprises 10 to 50 vol% of the oxide, it is more preferable that the sputtering target comprises 20 to 40 vol% of the oxide, and it is still more preferable that the sputtering target comprises 25 to 35 vol% of the oxide.

[0017]

The sputtering target can be preferably used for forming a magnetic thin film.

Advantageous Effects of Invention

[0018]

The present invention can provide a sputtering target with which it is possible to form a magnetic thin film having a high coercive force H_c .

BRIEF DESCRIPTION OF DRAWINGS

[0019]

FIG. 1 is a set of graphs showing hysteresis loops of magnetic thin films (CoPt alloy-oxide based magnetic thin films).

FIG. 2 is a graph showing a relationship between a melting point T_m of oxide and a coercive force H_c of magnetic thin film (CoPt alloy-oxide based magnetic thin films).

FIG. 3 is a graph showing a relationship between a standard

Gibbs free energy of formation ΔG_f of oxide with respect to 1mol O_2 and a coercive force H_c of magnetic thin film (CoPt alloy-oxide).

FIG. 4 is a metallurgical microscope photograph of the cross section in the thickness direction of a sintered test piece according to Example 1.

FIG. 5 is a metallurgical microscope photograph of the cross section in the thickness direction of a sintered test piece according to Example 1.

DESCRIPTION OF EMBODIMENTS

[0020]

A sputtering target according to an embodiment of the present invention contains metallic Co, metallic Pt, and an oxide, and is characterized in containing no metallic Cr except inevitable impurities, and in that the oxide consists of only B_2O_3 , and the sputtering target comprises 10 to 50 vol% of the B_2O_3 . In the present description, the metallic Co may be simply described as Co and the metallic Pt may be simply described as Pt.

[0021]

1. Components of Target

The sputtering target according to this embodiment contains Co and Pt as metallic components and may further contain other metals (for example, Au, Ag, Ru, Rh, Pd, Ir, W, Ta, Cu, B, Mo, etc.) unless these metals interfere with formation of the magnetic thin film.

As demonstrated in the earlier application of the inventors of the

present invention (Japanese Patent Application No. 2014-95566 and PCT/JP2015/061409), the sputtering target cannot contain metallic Cr except inevitable impurities because the presence of metallic Cr has an adverse effect on the magnetocrystalline anisotropy constant K_u of the resulting magnetic thin film.

[0022]

Metallic Co and metallic Pt are components of magnetic crystal grains (fine magnet) in the granular structure of the magnetic thin film formed by sputtering.

[0023]

Co is a ferromagnetic metal element and plays a central role in the formation of the magnetic crystal grains (fine magnet) in the granular structure of the magnetic thin film. In order to increase the magnetocrystalline anisotropy constant K_u of the CoPt alloy particles (magnetic crystal grains) in the magnetic thin film obtained by sputtering and to maintain the magnetism of the CoPt alloy particles in the obtained magnetic thin film, the content percentage of Co in the sputtering target according to this embodiment is preferably 20 to 90 at% and more preferably 25 to 85 at% relative to the total metallic components (the total of Co and Pt).

[0024]

Platinum, when alloying with Co in a predetermined composition range, has the function of reducing the magnetic moment of the alloy and thus has a role of adjusting the magnetic strength of the magnetic crystal grains. In order to increase the magnetocrystalline

anisotropy constant K_u of the CoPt alloy particles (magnetic crystal grains) in the magnetic thin film obtained by sputtering and to adjust the magnetism of the CoPt alloy particles (magnetic crystal grains) in the obtained magnetic thin film, the content percentage of Pt in the sputtering target according to this embodiment is preferably 10 to 80 at% and more preferably 15 to 75 at% relative to the total metallic components.

[0025]

The sputtering target according to this embodiment contains only B_2O_3 as an oxide component. The oxide component serves as a non-magnetic matrix that separates the magnetic crystal grains (fine magnet) from each other in the granular structure of the magnetic thin film.

[0026]

As demonstrated in Examples described below, using only B_2O_3 as an oxide is preferred because using only B_2O_3 as an oxide can significantly increase the coercive force H_c of the magnetic thin film deposited at room temperature.

[0027]

The content percentage of metallic components and the content percentage of oxide components in the entire sputtering target depend on the composition of a desired magnetic thin film. Although not limited, the content percentage of metallic components in the entire sputtering target may be, for example, 88 to 94 mol%, and the content percentage of oxide components in the entire sputtering target may

be, for example, 6 to 12 mol%.

[0028]

As described above, the oxide component serves as a non-magnetic matrix that separates the magnetic crystal grains (fine magnet) from each other in the granular structure of the magnetic thin film. Thus, a large oxide content in the magnetic thin film is preferred because it is easy to assuredly separate the magnetic crystal grains from each other and to make the magnetic crystal grains independent from each other. The oxide content in the sputtering target according to this embodiment is preferably 10 vol% or larger, and more preferably 20 vol% or larger, and still more preferably 25 vol% or larger.

[0029]

However, an excessively large oxide content in the magnetic thin film has an adverse effect on the crystallinity of the CoPt alloy particles (magnetic crystal grains) because the CoPt alloy particles (magnetic crystal grains) are contaminated with the oxide, which may increase the proportion of structures other than the hcp structure in the CoPt alloy particles (magnetic crystal grains). In addition, an excessively large oxide content in the magnetic thin film reduces the number of the magnetic crystal grains per unit area of the magnetic thin film and thus makes it difficult to increase the recording density. In light of such views, the oxide content in the sputtering target according to this embodiment is preferably 50 vol% or less, more preferably 40 vol% or less, and

still more preferably 35 vol% or less.

[0030]

Therefore, the oxide content in the sputtering target according to this embodiment relative to the entire sputtering target is preferably 10 to 50 vol%, more preferably 20 to 40 vol%, and still more preferably 25 to 35 vol%.

[0031]

2. Microstructure of Sputtering Target

The microstructure of the sputtering target according to this embodiment is not particularly limited, but is preferably a microstructure in which a metal phase and an oxide phase are finely dispersed in each other. Such a microstructure makes it difficult to generate defects such as nodules and particles during sputtering.

[0032]

3. Process for Production of Sputtering Target

The sputtering target according to this embodiment can be produced, for example, in the following manner.

[0033]

(1) Preparation of CoPt Alloy-Atomized Powder

Co and Pt are weighed so as to obtain a prescribed composition (the atomic ratio of metallic Co to the total of the metallic Co and metallic Pt is 20 to 90 at%), and a molten CoPt alloy is produced. Subsequently, the molten CoPt alloy is gas-atomized to prepare a CoPt alloy-atomized powder having a prescribed composition (the atomic ratio of metallic Co to the total of the metallic Co and

metallic Pt is preferably 20 to 90 at%). The produced CoPt alloy-atomized powder is classified so that the particle size becomes not larger than a predetermined particle size (for example, 106 μm or smaller).

5 [0034]

In order to increase the magnetism of the CoPt alloy-atomized powder, the atomic ratio of metallic Co to the total of the metallic Co and metallic Pt contained in the powder is preferably 25 at% or larger and more preferably 30 at% or larger.

10 [0035]

(2) Preparation of Powder Mixture for Pressure Sintering

AB_2O_3 powder is added to the CoPt alloy-atomized powder prepared in (1). The mixture is dispersedly mixed with a ball mill to prepare a powder mixture for pressure sintering. By dispersedly mixing the
15 CoPt alloy-atomized powder and the B_2O_3 powder with the ball mill, a powder mixture for pressure sintering in which the CoPt alloy-atomized powder and the B_2O_3 powder are finely dispersed in each other can be prepared.

[0036]

20 In the magnetic thin film formed by using the obtained sputtering target, the volume fraction of the B_2O_3 powder in the entire powder mixture for pressure sintering is preferably 10 to 50 vol%, more preferably 20 to 40 vol%, and still more preferably 25 to 35 vol% in order to easily make the magnetic crystal grains
25 independent from each other by assuredly separating the magnetic

crystal grains from each other by B_2O_3 , to makes it easy for the CoPt alloy particles (magnetic crystal grains) to have the hcp structure, and to increase the recording density.

[0037]

5 (3) Molding

The powder mixture for pressure sintering prepared in (2) is pressure-sintered and molded using, for example, a vacuum hot pressing method to produce a sputtering target. Since the powder mixture for pressure sintering prepared in (2) has been dispersedly
10 mixed with a ball mill and the CoPt alloy-atomized powder and the B_2O_3 powder are finely dispersed in each other, defects such as generation of nodules and particles are unlikely to occur during sputtering using the sputtering target obtained by this production process.

15 [0038]

The method for pressure-sintering the powder mixture for pressure sintering is not limited. The method may be a method other than a vacuum hot pressing method and may be, for example, a HIP method.

20 [0039]

(4) Modification

The example production process described in (1) to (3) involves preparing the CoPt alloy-atomized powder by an atomizing method, adding the B_2O_3 powder to the prepared CoPt alloy-atomized powder,
25 and dispersedly mixing the mixture with the ball mill to prepare

the powder mixture for pressure sintering. A Co single powder and a Pt single powder may be used instead of using the CoPt alloy-atomized powder. In such a case, three types of powder, which are a Co single powder, a Pt single powder, and a B₂O₃ powder, are dispersedly mixed with a ball mill to prepare a powder mixture for pressure sintering.

EXAMPLES

[0040]

As demonstrated in the earlier application of the inventors of the present invention (Japanese Patent Application No. 2014-95566 and PCT/JP2015/061409), since the presence of metallic Cr has an adverse effect on the magnetocrystalline anisotropy constant K_u of the resulting magnetic thin film, sputtering targets for use in formation of magnetic thin films are free of metallic Cr except inevitable impurities in the present invention.

[0041]

In Examples and Comparative Examples described below, studies were carried out using 13 types of oxides in total, provided that the sputtering targets for use in formation of the magnetic thin films were free of metallic Cr except inevitable impurities (the magnetic crystal grains in the magnetic thin film were formed from a CoPt alloy that did not contain metallic Cr except inevitable impurities).

[0042]

(Example 1)

A magnetic recording film was formed by sputtering with a DC sputtering apparatus. The magnetic recording film was formed on a glass substrate. The stacked structure of the formed magnetic recording film includes, in order of increasing distance from the glass substrate, Ta (5 nm, 0.6 Pa) / Pt (6 nm, 0.6 Pa) / Ru (10 nm, 0.6 Pa) / Ru (10 nm, 8 Pa) / Co₆₀Cr₄₀-26vol%SiO₂ (2 nm, 4 Pa) / CoPt alloy-B₂O₃ (16 nm, 8 Pa) / C (7 nm, 0.6 Pa). The number on the left side in parenthesis indicates the film thickness, and the number on the right side indicates the pressure of an Ar atmosphere during sputtering. CoPt alloy-B₂O₃ is a magnetic thin film that serves as the recording layer of a perpendicular magnetic recording medium.

[0043]

The composition of the entire target prepared as Example 1 is 91.4(80Co-20Pt)-7.5B₂O₃ in terms of molar ratio. The target was prepared and evaluated in the following manner. The composition of the entire target prepared in Example 1, when the content percentage of the oxide (B₂O₃) is expressed as the volume fraction in the entire target, is (80Co-20Pt)-30vol%B₂O₃.

[0044]

To prepare the target according to Example 1, an 80Co-20Pt alloy-atomized powder was prepared first. Specifically, metals were weighed so as to obtain an alloy composition of Co: 80 at% and Pt: 20 at% and heated to 1500°C or higher to prepare a molten alloy. The molten alloy was gas-atomized to prepare an 80Co-20Pt

alloy-atomized powder.

[0045]

The prepared 80Co-20Pt alloy-atomized powder was separately classified through 150 mesh sieves to obtain 80Co-20Pt

5 alloy-atomized powder having a particle diameter of $106\text{ }\mu\text{m}$ or smaller.

[0046]

To 1150 g of the classified 80Co-20Pt alloy-atomized powder, 74.78 g of a B_2O_3 powder was added. Then, the mixture was mixed and dispersed by a ball mill to obtain a powder mixture for pressure
10 sintering. The cumulative rotation number of a ball mill was 2,805,840.

[0047]

The obtained powder mixture (30 g) for pressure sintering was subjected to hot pressing under the conditions of sintering
15 temperature: 720°C , pressure: 24.5 MPa, time: 30 min, and atmosphere: 5×10^{-2} Pa or lower to prepare a sintered test piece (ϕ 30 mm). The relative density of the prepared sintered test piece was 99.009%. The calculated density is 9.04 g/cm^3 .

[0048]

20 FIG. 4 and FIG. 5 are metallurgical microscope photograph of the cross section in the thickness direction of the obtained sintered test piece. FIG. 4 is a photograph at a photographing magnification of 100 times (a bar scale in the photograph represents $500\text{ }\mu\text{m}$), and
FIG. 5 is a photograph at a photographing magnification of 500 times
25 (a bar scale in the photograph represents $100\text{ }\mu\text{m}$).

[0049]

As can be seen from FIG. 4 and FIG. 5, the 80Co-20Pt-alloy phase and the B₂O₃ phase were finely dispersed in and mixed with each other.

5 [0050]

Next, the prepared powder mixture for pressure sintering was subjected to hot pressing under the conditions of sintering temperature: 720°C, pressure: 24.5 MPa, time: 60 min, and atmosphere: 5×10^{-2} Pa or lower to prepare a target with $\phi 153.0 \times 1.0$ mm + $\phi 161.0$
10 $\times 4.0$ mm. The relative density of the prepared target was 101.0%.

[0051]

The prepared target was evaluated for leakage flux on the basis of ASTM F2086-01. As a result, the average magnetic leakage flux rate was 30.9%. This average magnetic leakage flux rate is sufficient
15 for favorable magnetron sputtering.

[0052]

Next, a magnetic thin film made of (80Co-20Pt)-30vol%B₂O₃ was deposited on a substrate by magnetron sputtering using the prepared target to produce a sample for determining magnetic properties.
20 The stacked structure of this sample for determining magnetic properties includes, as was described earlier, in order of increasing distance from the glass substrate, glass/Ta (5 nm, 0.6 Pa) / Pt (6 nm, 0.6 Pa) / Ru (10 nm, 0.6 Pa) / Ru (10 nm, 8 Pa) / Co₆₀Cr₄₀-26vol%SiO₂ (2 nm, 4 Pa) / CoPt alloy-B₂O₃ (16 nm, 8 Pa) / C (7 nm, 0.6 Pa).
25 The number on the left side in parenthesis indicates the film thickness,

and the number on the right side indicates the pressure of an Ar atmosphere during sputtering.

[0053]

CoPt alloy-B₂O₃ is a magnetic thin film deposited by using
5 the target prepared in present Example. This magnetic thin film was deposited at room temperature without heating the substrate during film deposition.

[0054]

The hysteresis loop was measured using a magneto-optical Kerr
10 effect apparatus for the resulting sample for determining magnetic properties thereof. The coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 8.8 kOe. It should be noted that the coercive forces H_c of magnetic thin films available on the basis of the current technology
15 are about 6 to 7 kOe.

[0055]

The hysteresis loop of Example 1 is shown in FIG. 1 together with the results of other Comparative Examples. The horizontal axis of FIG. 1 represents the strength of the magnetic field applied.
20 The vertical axis of FIG. 1 represents the value normalized by dividing the rotation angle (Kerr rotation angle) of the polarization axis of incident light by the saturation Kerr rotation angle.

[0056]

FIGS. 2 and 3 show the measured result of the coercive force
25 H_c together with the results of Comparative Examples. The vertical

axis of FIGS. 2 and 3 represents the coercive force H_c while the horizontal axis of FIG. 2 represents a melting point T_m ($^{\circ}\text{C}$) of oxide and the horizontal axis of FIG. 3 represents a standard Gibbs free energy of formation ΔG_f (kJ/mol O_2) with respect to 1mol O_2 when oxide is formed.

[0057]

(Comparative Example 1)

The composition of the entire target prepared as Comparative Example 1 is $(80\text{Co}-20\text{Pt})-30\text{vol}\%\text{WO}_3$. A target was prepared in the same manner as in Example 1 except that WO_3 was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0058]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 7.1 kOe . The hysteresis loop of Comparative Example 1 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0059]

(Comparative Example 2)

The composition of the entire target prepared as Comparative

Example 2 is (80Co-20Pt)-30vol%TiO₂. A target was prepared in the same manner as in Example 1 except that TiO₂ was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

5 [0060]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 5.8 kOe. The hysteresis loop of Comparative Example 2 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

15 [0061]

(Comparative Example 3)

The composition of the entire target prepared as Comparative Example 3 is (80Co-20Pt)-30vol%SiO₂. A target was prepared in the same manner as in Example 1 except that SiO₂ was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0062]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c

was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 5.2 kOe. The hysteresis loop of Comparative Example 3 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0063]

(Comparative Example 4)

The composition of the entire target prepared as Comparative Example 4 is (80Co-20Pt)-30vol% Al_2O_3 . A target was prepared in the same manner as in Example 1 except that Al_2O_3 was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0064]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 0.8 kOe. The hysteresis loop of Comparative Example 4 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0065]

(Comparative Example 5)

The composition of the entire target prepared as Comparative Example 5 is (80Co-20Pt)-30vol%MoO₃. A target was prepared in the same manner as in Example 1 except that MoO₃ was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0066]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 5.1 kOe. The hysteresis loop of Comparative Example 5 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0067]

(Comparative Example 6)

The composition of the entire target prepared as Comparative Example 6 is (80Co-20Pt)-30vol%ZrO₂. A target was prepared in the same manner as in Example 1 except that ZrO₂ was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0068]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties

in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 1.6 kOe. The hysteresis loop of Comparative Example 6 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0069]

(Comparative Example 7)

The composition of the entire target prepared as Comparative Example 7 is (80Co-20Pt)-30vol%Co₃O₄. A target was prepared in the same manner as in Example 1 except that Co₃O₄ was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0070]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 4.7 kOe. The hysteresis loop of Comparative Example 7 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0071]

(Comparative Example 8)

The composition of the entire target prepared as Comparative Example 8 is (80Co-20Pt)-30vol%MnO. A target was prepared in the same manner as in Example 1 except that MnO was used as an oxide.

5 Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0072]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force Hc was read from the hysteresis loop. As a result, the read value of the coercive force Hc was 5.6 kOe. The hysteresis loop of Comparative Example 8 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force Hc together with the results of other Examples and Comparative Examples.

[0073]

(Comparative Example 9)

The composition of the entire target prepared as Comparative Example 9 is (80Co-20Pt)-30vol%Cr₂O₃. A target was prepared in the same manner as in Example 1 except that Cr₂O₃ was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0074]

25 The hysteresis loop was measured, using a magneto-optical Kerr

effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 3.3 kOe. The hysteresis loop of Comparative Example 9 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0075]

10 (Comparative Example 10)

The composition of the entire target prepared as Comparative Example 10 is (80Co-20Pt)-30vol% Y_2O_3 . A target was prepared in the same manner as in Example 1 except that Y_2O_3 was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0076]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 1.2 kOe. The hysteresis loop of Comparative Example 10 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0077]

(Comparative Example 11)

The composition of the entire target prepared as Comparative Example 11 is (80Co-20Pt)-30vol%WO₂. A target was prepared in the same manner as in Example 1 except that WO₂ was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0078]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop. As a result, the read value of the coercive force H_c was 3.3 kOe. The hysteresis loop of Comparative Example 11 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force H_c together with the results of other Examples and Comparative Examples.

[0079]

(Comparative Example 12)

The composition of the entire target prepared as Comparative Example 12 is (80Co-20Pt)-30vol%Mn₃O₄. A target was prepared in the same manner as in Example 1 except that Mn₃O₄ was used as an oxide. Samples for determining magnetic properties were also prepared in the same manner as in Example 1 by using the prepared target.

[0080]

The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force Hc was read from the hysteresis loop. As a result, the read value of the coercive force Hc was 5.3 kOe. The hysteresis loop of Comparative Example 12 is shown in FIG. 1 together with the results of other Examples and Comparative Examples. FIGS. 2 and 3 also show the measured result of the coercive force Hc together with the results of other Examples and Comparative Examples.

[0081]

- Discussion about types of oxides (Example 1 and Comparative Examples 1 to 12) -

The following table 1 lists the melting points and the standard Gibbs free energies ΔG_f of formation with respect to 1mol O₂ of the oxides used in Example 1 and Comparative Examples 1 to 12, and the values of the coercive forces Hc of the magnetic thin films obtained as the samples for determining magnetic properties of Example 1 and Comparative Examples 1 to 12. Note that the content of each of the oxides used in Example 1 and Comparative Examples 1 to 12 is 30 vol% relative to the entire target.

[0082]

[Table 1]

oxide	oxide content (vol%)	melting point T _m (°C)	ΔG _f (kJ/mol O ₂)	Coercive force H _c (kOe)
B ₂ O ₃ (Example 1)	30	450	-795.8	8.8
WO ₃ (Comparative Example 1)	30	2473	-509.4	7.1
TiO ₂ (Comparative Example 2)	30	1843	-885.0	5.8
SiO ₂ (Comparative Example 3)	30	1600	-856.7	5.2
Al ₂ O ₃ (Comparative Example 4)	30	2072	-1054.6	0.8
MoO ₃ (Comparative Example 5)	30	795	-445.3	5.1
ZrO ₂ (Comparative Example 6)	30	2700	-1042.8	1.6
Co ₃ O ₄ (Comparative Example 7)	30	895	-397.1	4.7
MnO (Comparative Example 8)	30	1945	-725.8	5.6
Cr ₂ O ₃ (Comparative Example 9)	30	2435	-705.3	3.3
Y ₂ O ₃ (Comparative Example 10)	30	2425	-1151.3	1.2
WO ₂ (Comparative Example 11)	30	1700	-533.9	3.3
Mn ₃ O ₄ (Comparative Example 12)	30	1564	-641.5	5.3

[0083]

As can be seen from Table 1 and FIGS. 2 and 3, the value of the coercive force H_c of the magnetic thin film tends to increase as the melting point T_m of the used oxide becomes lower, and the value is remarkably large when the melting point is 600°C or lower.

5 On the other hand, when the standard Gibbs free energy of formation ΔG_f of the oxide with respect to 1mol O_2 is considered, the value of the coercive force H_c of the magnetic thin film tends to increase if the standard Gibbs free energy of formation ΔG_f of the oxide falls within the range of -1,000 kJ/mol O_2 or more and -500 kJ/mol
10 O_2 or less.

[0084]

Thus, the oxide suitable for increasing the coercive force H_c of the magnetic thin film is considered to have a melting point of 600°C or lower and a standard Gibbs free energy of formation ΔG_f
15 with respect to 1mol O_2 being -1,000 kJ/mol O_2 or more and -500 kJ/mol O_2 or less.

[0085]

At present it is uncertain why the oxide suitable for increasing the coercive force H_c of the magnetic thin film has a melting point
20 of 600°C or lower and a standard Gibbs free energy of formation ΔG_f with respect to 1mol O_2 being -1,000 kJ/mol O_2 or more and -500 kJ/mol O_2 or less. However, why the value of the coercive force H_c of the magnetic thin film tends to increase as the melting point T_m of the used oxide becomes lower can be explained as follows.

25 Specifically, the Ru layer located at the lower layer than the magnetic

thin film (closer to the substrate) has a surface with irregularities. During the cooling process after sputtering, the CoPt alloy, which has a relatively high melting point of 1460°C, is first selectively deposited on the projected portions of the Ru layer

5 (Co₆₀Cr₄₀-26vol%SiO₂ layer on the surface of the projected portion of the Ru layer) to grow in a columnar shape while the oxide having the low melting point is still in a liquid state. Thus, it is assumed that the oxide in the liquid state is present between the CoPt alloy particles growing in a columnar shape. As the cooling progresses
10 further, the liquid oxide present between the CoPt alloy particles is solidified, and the oxide becomes wall body to separate between the CoPt alloy particles having grown in a columnar shape and form a granular structure.

[0086]

15 Thus, the use of an oxide having a low melting point assuredly separates the CoPt alloy particles by the wall body of the oxide. As the result, the interaction between the CoPt alloy particles becomes small. Thus, it is assumed that the magnetic thin film using the oxide having a low melting point has a larger coercive force
20 H_c.

[0087]

Note that the smaller the standard Gibbs free energy of formation ΔG_f of an oxide with respect to 1mol O₂ is (larger minus value), the more stable the oxide is as an oxide. From the viewpoint
25 of this, it is assumed that the smaller standard Gibbs free energy

of formation ΔG_f of an oxide (ΔG_f of larger minus value) with respect to 1mol O_2 is preferred.

[0088]

Further, as can be seen from Table 1, the oxide B_2O_3 used for the sputtering target of Example 1 has a melting point T_m of 450°C, which is equal to or lower than 600°C, and the standard Gibbs free energy of formation ΔG_f with respect to 1mol O_2 of -795.8 kJ/mol O_2 , which is -1,000 kJ/mol O_2 or more and -500 kJ/mol O_2 or less. The sputtering target of Example 1 is encompassed by the present invention. The coercive force H_c of the sample for determining magnetic properties produced in Example 1 is 8.8 kOe, which is remarkably larger than those of Comparative Examples 1 to 12 using other oxides, and the sample produced in Example 1 is the only sample that has the coercive force H_c exceeding 8 kOe.

[0089]

Therefore, it is assumed that the most appropriate means to increase the coercive force H_c of the CoPt alloy-oxide based magnetic thin film is to use the CoPt alloy-oxide based target using B_2O_3 as in Example 1.

[0090]

- Additional studies about content of oxide (Examples 2 to 8) -

As discussed above, the previous studies suggest that the most appropriate means to increase the coercive force H_c of the CoPt alloy-oxide based magnetic thin film is to use the CoPt alloy-oxide based target using B_2O_3 as in Example 1.

[0091]

However, the B_2O_3 content in the sputtering targets used in Example 1 was 30 vol%, only one type of content.

[0092]

5 Therefore, additional studies were carried out by producing a plurality of targets (the composition of Co and Pt was 80Co-20Pt) in the same manner as in Example 1 except that the content of B_2O_3 was changed. The B_2O_3 contents in the sputtering targets in additional studies (Examples 2 to 8) were 10 vol% in Example 2,
10 15 vol% in Example 3, 20 vol% in Example 4, 25 vol% in Example 5, 35 vol% in Example 6, 40 vol% in Example 7, and 50 vol% in Example 8. Samples for determining magnetic properties were prepared in the same manner as in Example 1 by using the prepared target.

[0093]

15 The hysteresis loop was measured, using a magneto-optical Kerr effect apparatus, for the sample for determining magnetic properties in the same manner as in Example 1. Then, the coercive force H_c was read from the hysteresis loop.

[0094]

20 The following table 2 lists these measurement results together with the measurement results of Example 1.

[0095]

[Table 2]

oxide	oxide content (vol%)	Coercive force Hc (kOe)
B ₂ O ₃ (Example 2)	10	5.5
B ₂ O ₃ (Example 3)	15	7.1
B ₂ O ₃ (Example 4)	20	7.6
B ₂ O ₃ (Example 5)	25	8.2
B ₂ O ₃ (Example 1)	30	8.8
B ₂ O ₃ (Example 6)	35	8.5
B ₂ O ₃ (Example 7)	40	8.1
B ₂ O ₃ (Example 8)	50	6.2

[0096]

5 As can be seen from Table 2, all the coercive forces Hc in
Examples 1 to 8 exceed 5 kOe, showing favorable results. Thus, when
the CoPt-oxide target using B₂O₃ as the oxide is used and the content
of B₂O₃ relative to the entire target is 10 vol% or more and 50 vol%
or less, it is assumed that the favorable magnetic thin film having
10 a coercive force Hc exceeding 5 kOe can be obtained.

[0097]

Furthermore, as can be seen from Table 2, when the content
of B₂O₃ relative to the entire target is 20 vol% or more and 40 vol%

or less, the favorable magnetic thin films having a coercive force H_c of 7.6 kOe or larger are obtained. Thus, it is assumed that the content of B_2O_3 relative to the entire target should more preferably be 20 vol% or more and 40 vol% or less.

5 [0098]

Furthermore, as can be seen from Table 2, when the content of B_2O_3 relative to the entire target is 25 vol% or more and 35 vol% or less, the favorable magnetic thin films having a coercive force H_c of 8.2 kOe or larger are obtained. Thus, it is assumed that the
10 content of B_2O_3 relative to the entire target should particularly preferably be 25 vol% or more and 35 vol% or less.

Industrial Applicability

[0099]

15 The sputtering target according to the present invention is a sputtering target with which a magnetic thin film having a high coercive force can be fabricated, and thus has industrial applicability.

CLAIMS

1. A sputtering target comprising metallic Co, metallic Pt, and an oxide, wherein

the sputtering target contains no metallic Cr except inevitable

5 impurities,

the oxide consists of only B_2O_3 , and

the sputtering target comprises 10 to 50 vol% of the B_2O_3 .

2. The sputtering target according to claim 1, wherein the

10 sputtering target comprises 20 to 40 vol% of the B_2O_3 .

3. The sputtering target according to claim 1, wherein the

sputtering target comprises 25 to 35 vol% of the B_2O_3 .

15 4. The sputtering target according to any one of claims 1 to 3, wherein the sputtering target can be used for forming a magnetic thin film.